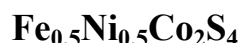


Support Information

Proposed electron transmission mechanism between $\text{Fe}^{3+}/\text{Co}^{2+}$ and $\text{Fe}^{3+}/\text{Fe}^{3+}$ in spinel structure and its practical evidence on quaternary



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Table S1. The etching parameters of the two samples.

Sample	Etching element	Source Gun Tyoe	Total acquistit ion time	Number of Energy steps	Eneyg step Size	Etching Time
$\text{Fe}_{0.5}\text{Ni}_{0.5}\text{Co}_2\text{O}_4$	Ar ion	Al K α	1 min 8.0 secs	1361	1.00 eV	~3000 s
$\text{Fe}_{0.5}\text{Ni}_{0.5}\text{Co}_2\text{S}_4$	Ar iron	Al K α	1 min 8.0 secs	1361	1.000 eV	~3000 s

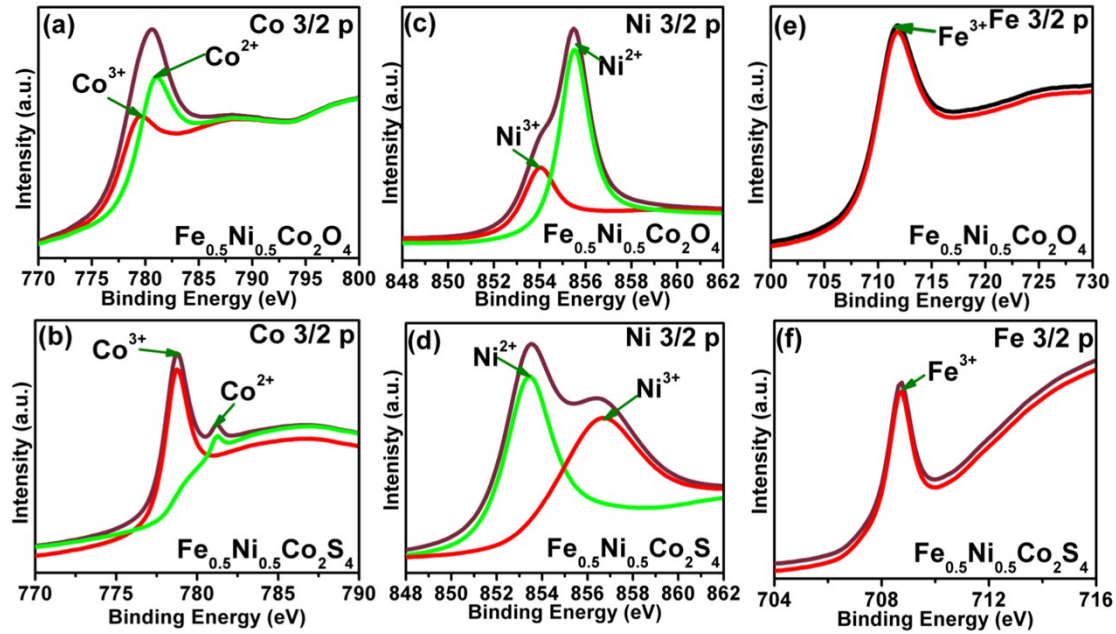


Figure S1. XPS data of $\text{Fe}_{0.5}\text{Ni}_{0.5}\text{Co}_2\text{O}_4$ and $\text{Fe}_{0.5}\text{Ni}_{0.5}\text{Co}_2\text{S}_4$ treated by Ar-cluster etching technique: (a, c, e): Co 3/2p, Ni 3/2p, Fe 3/2p of $\text{Fe}_{0.5}\text{Ni}_{0.5}\text{Co}_2\text{O}_4$; (b, d, f) Co3/2p, Ni 3/2p, Fe 3/2p of $\text{Fe}_{0.5}\text{Ni}_{0.5}\text{Co}_2\text{S}_4$.

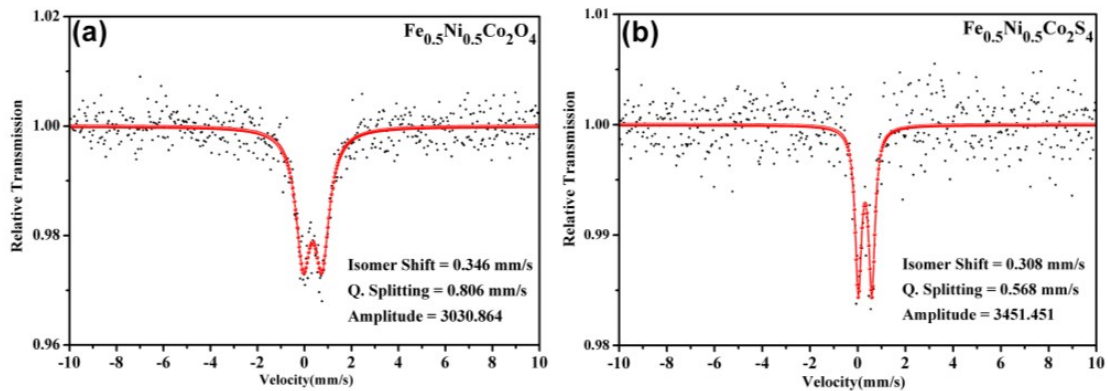


Figure S2. The Mössbauer of $\text{Fe}_{0.5}\text{Ni}_{0.5}\text{Co}_2\text{O}_4$ and $\text{Fe}_{0.5}\text{Ni}_{0.5}\text{Co}_2\text{S}_4$.

According to the Isomer shift value, we can get information that the Fe ions in both two samples presented tervalence. Besides, Fe^{3+} only can be found at B sites.¹⁻²

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